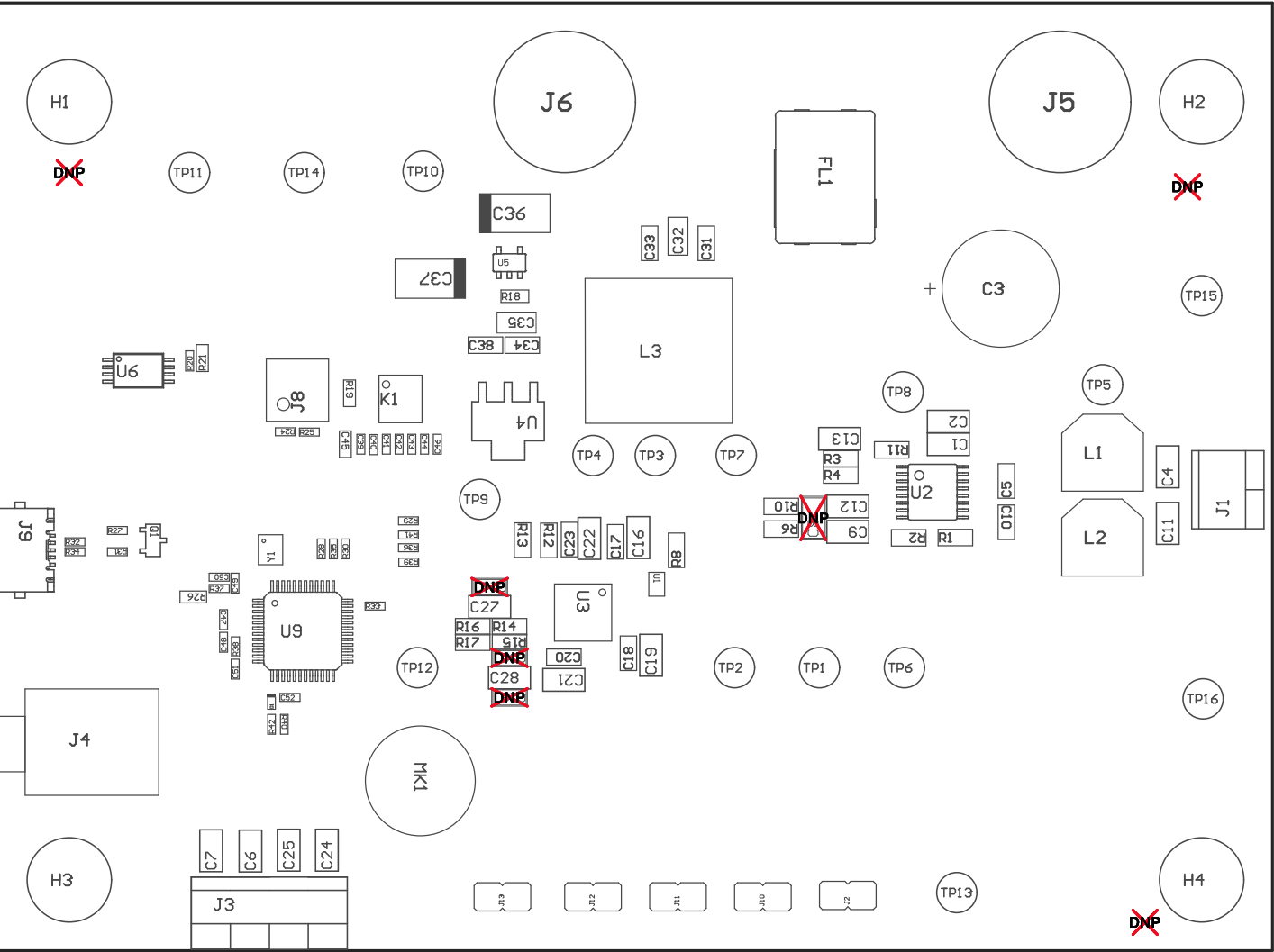
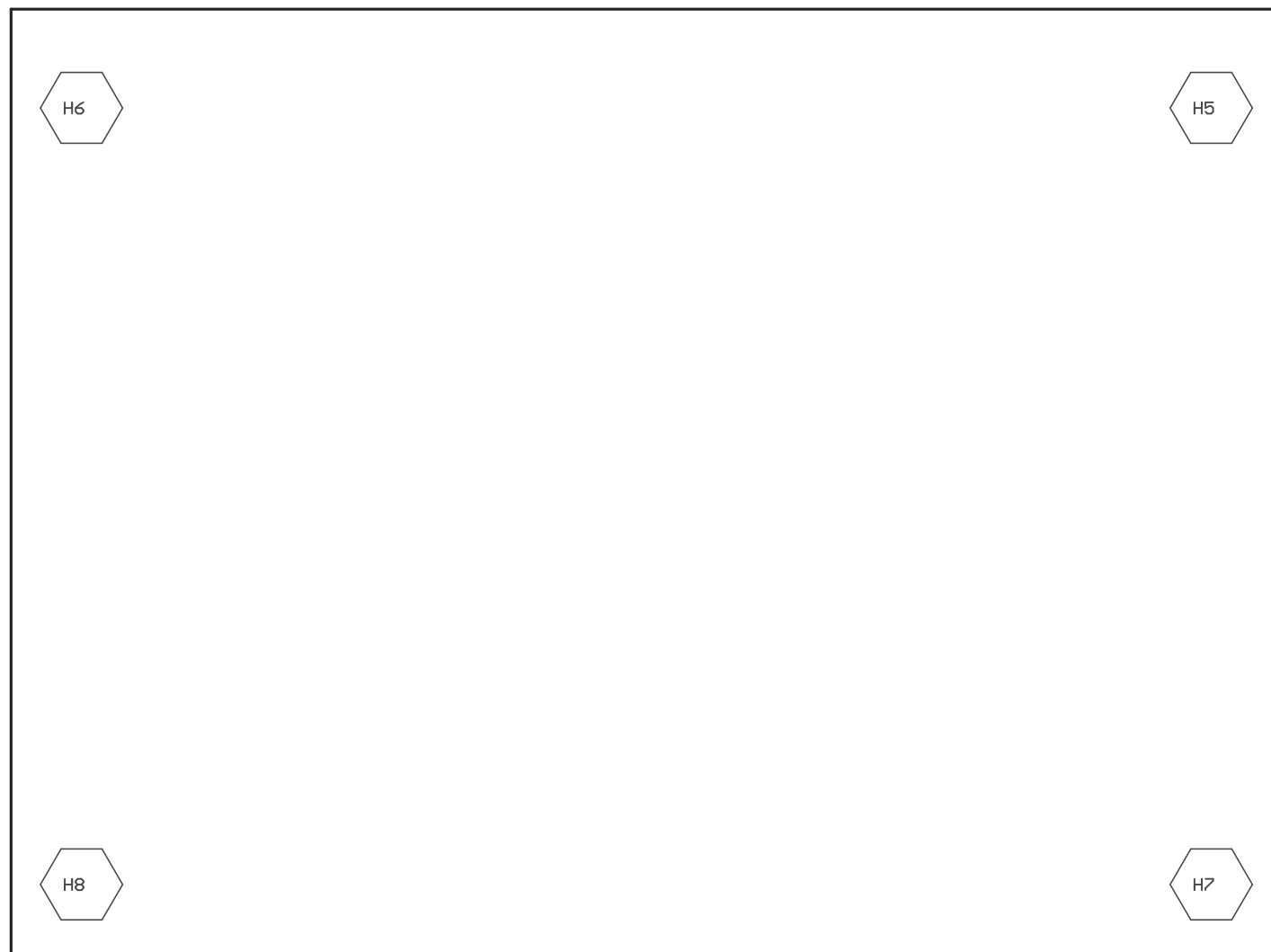


Z21 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
Z22 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
Z23 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00724	REV: A	SVN REV: Not In VersionControl
	TID #:	TIDA-00724	
PLOT NAME = Top Assembly Drawing	GENERATED : 11/23/2015 2:24:38 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00724	REV: A	SVN REV: Not In VersionControl
	TID #: TIDA-00724		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/23/2015 2:24:45 PM		TEXAS INSTRUMENTS

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